

AMENDMENTS TO THE CLAIMS:

1. (Currently Amended) A heat-dissipating fan module of an electronic apparatus, comprising:

a casing having an opening, said opening having an airflow guiding device formed integrally therewith and along an edge thereof ~~metal material of the opening, wherein material that is removed to form said opening forms the guiding device by bending the material;~~ and

a heat-dissipating fan fixed into one side of said casing and correspondingly disposed on said opening.

2. (Original) The heat-dissipating fan module according to claim 1 wherein said guiding device is a metal material disposed on said edge portion of said opening, extended from said edge of said opening, and inclined toward the axis of the opening.

3. (Original) The heat-dissipating fan module according to claim 1 wherein said casing and said guiding device are disposed to form a particular angle.

4. (Original) The heat-dissipating fan module according to claim 3 wherein said particular angle is substantially 5 to 90 degrees.

5. (Original) The heat-dissipating fan module according to claim 1 wherein said heat-dissipating fan is a fan without a frame.

6. (Original) The heat-dissipating fan module according to claim 1 wherein said casing further comprises a reticular portion integrally formed therewith and disposed at the corresponding position of said opening.

7. (Original) The heat-dissipating fan module according to claim 1 further comprising a reticular plate, wherein said reticular plate is separably fixed to one side of said casing for covering said opening.

8. (Original) The heat-dissipating fan module according to claim 1 wherein said electronic apparatus is a power supply.